



Date: May 16, 1995

Reference: Standards Proposal No. 3389, Proposed New Standard "PCS 1900 Air Interface Specification" (if approved, to be published as J-STD-007)

Company Name: Hitachi Telecom (USA), Inc.

Address: 3617 Parkway Lane

Norcross, GA 30092

Contact Person Regarding Patents and Intellectual Property Matters:

Michael Medin

(Name Printed)

Title: Director - Systems Engineering

Telephone and FAX: (T) 770-446-8820 (F) 770-242-1414

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NOTE: If not attached, indicate when the envelope will be received at TIA. Indicate the company name and proposed Standard number on the outside. Date due at TIA: \_\_\_\_\_.

Agreed, on behalf of the above Company: Michael W Medin  
(Signature)

Name (printed): Michael Medin

Date: 7/14/95